

KSC5047

Feature

- High Current Gain
- Low Collector Emitter Saturation Voltage



NPN Epitaxial Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V _{CBO}	Collector-Base Voltage	100	V	
V _{CEO}	Collector-Emitter Voltage	50	V	
V _{EBO}	Emitter-Base Voltage	15	V	
I _C	Collector Current	15	А	
I _B	Base Current	4	Α	
P _C	Collector Dissipation (T _C =25°C)	100	W	
T _J	Junction Temperature	150	°C	
T _{STG}	Storage Temperature	- 55 ~ 150	°C	

Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 50 \text{mA}, I_B = 0$	50			V
I _{CBO}	Collector Cut-off Current	$V_{CB} = 100V, I_{E} = 0$			100	μΑ
I _{EBO}	Emitter-Base Breakdown Voltage	$V_{EB} = 15V, I_{C} = 0$			100	μΑ
h _{FE}	DC Current Gain	$V_{CE} = 5V, I_{C} = 5A$	40			
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_C = 5A, I_B = 0.12A$			0.5	V
V _{BE} (sat)	Base-Emitter Saturation Voltage	$I_C = 5A, I_B = 0.12A$			1.2	V
t _{ON}	Turn On Time	$V_{CC} = 20V, I_{C} = 5A$		0.5		μs
t _{STG}	Storage Time	$I_{B1} = -I_{B2} = 0.12A$		2.5	OZ.	μs
t _F	Fall Time	$R_L = 4\Omega$		0.5		μs

Typical Characteristics

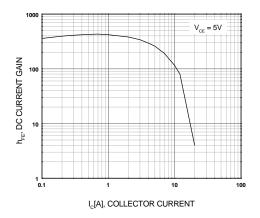


Figure 1. DC current Gain

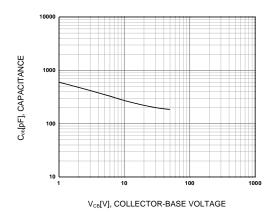


Figure 3. Collector Output Capacitance

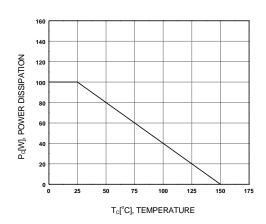


Figure 5. Power Derating

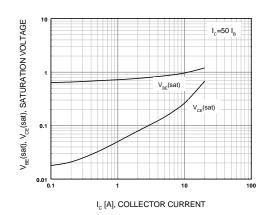
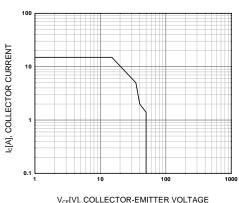


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage



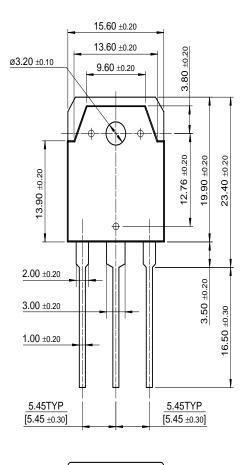
 $V_{\text{CE}}[V],\, \text{COLLECTOR-EMITTER}\,\, \text{VOLTAGE}$

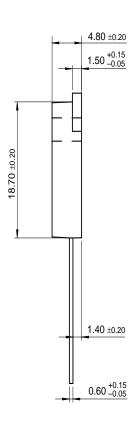
Figure 4. Safe Operating Area

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Package Dimensions

TO-3P





Dimensions in Millimeters

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